

MEG 2

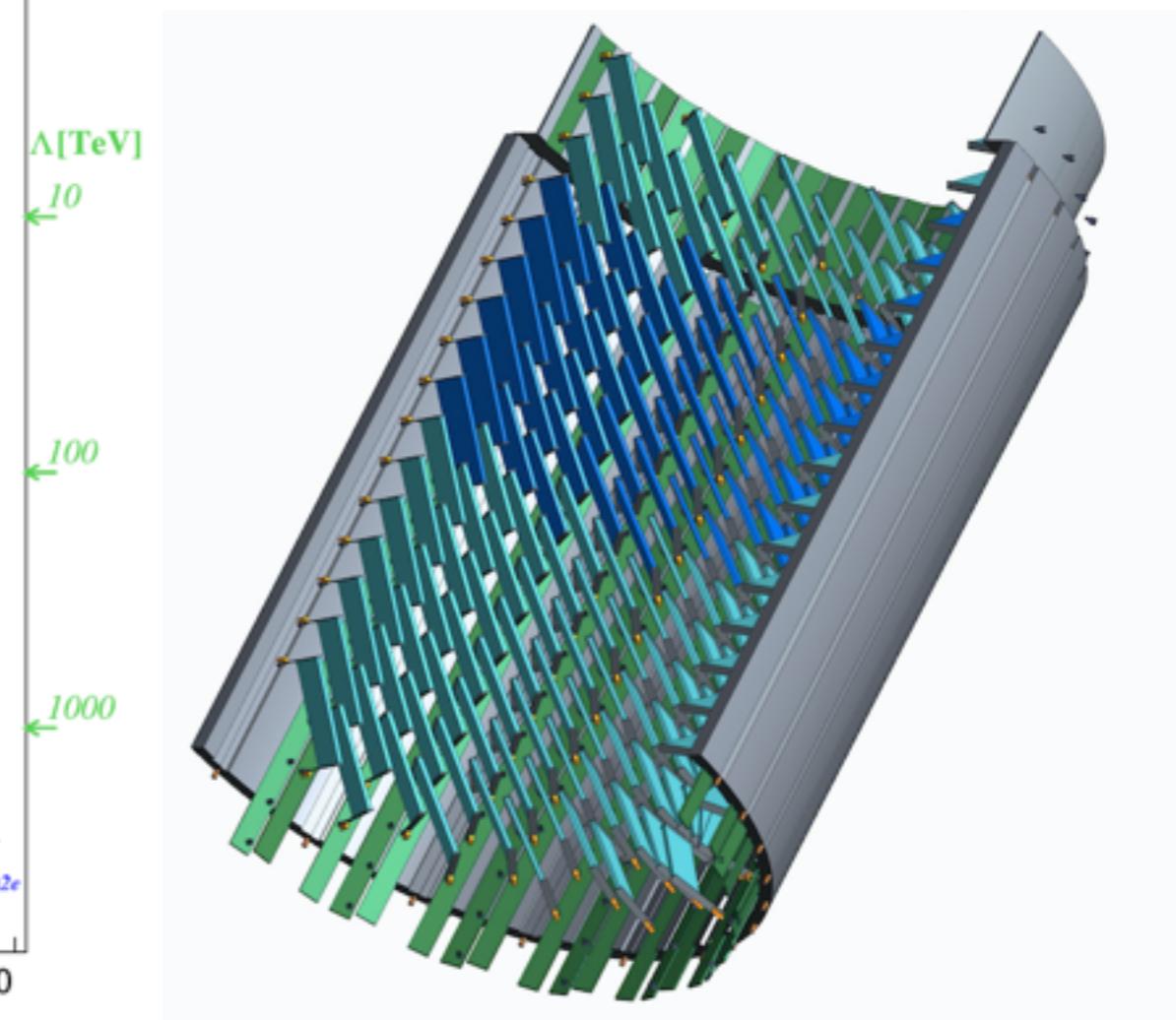
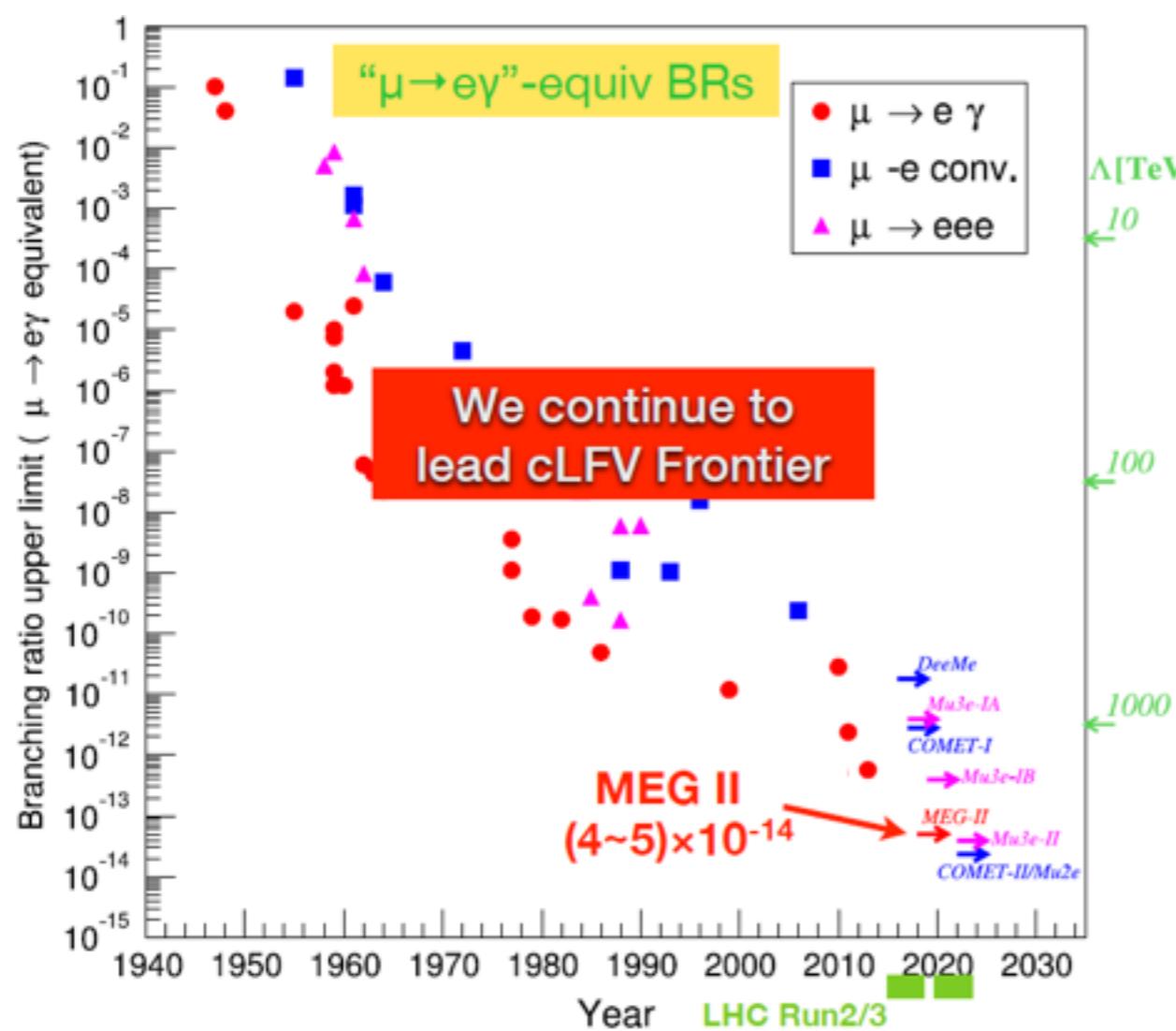
Cds Preventivi 2016
Flavio Gatti

MEG.

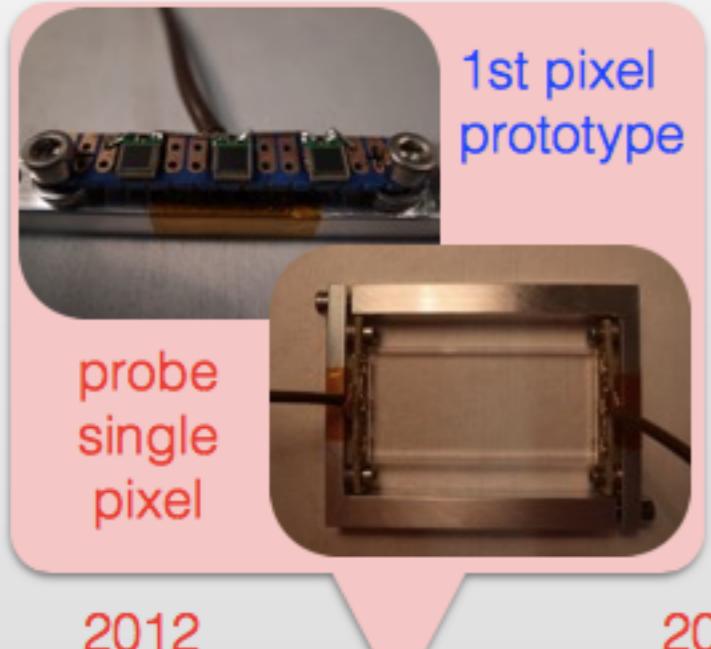
Investigazioni sulla fisica oltre il modello standard con la ricerca del decadimento che viola la Conservazione del Sapore Leptonico: $\mu \rightarrow e \gamma$.

Una lunga storia che inizia con Pontecorvo

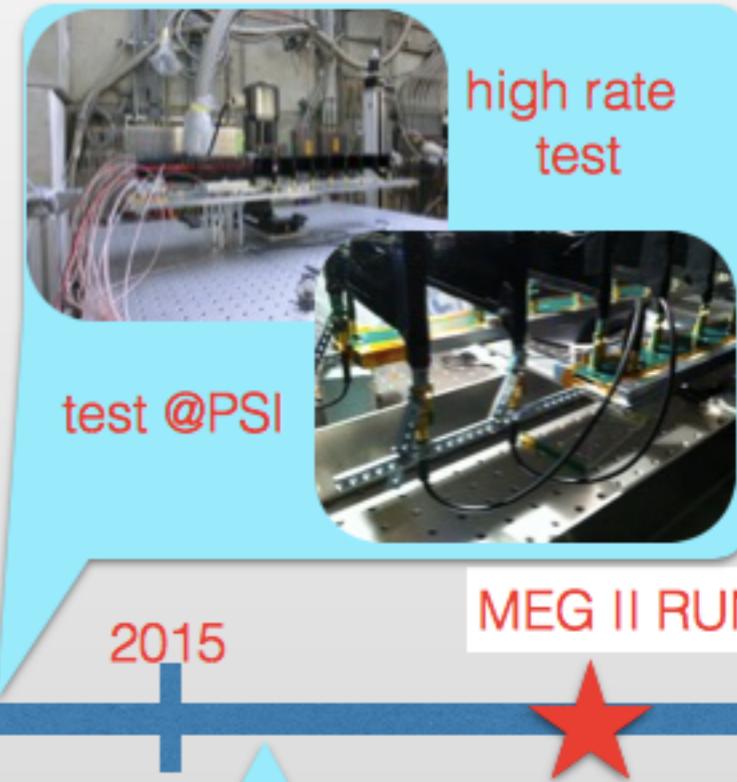
Genova responsabile del Timing Counter di MEG1. Ora Co-responsabile con Tokyo di un progetto più ambizioso con risoluzioni temporali di 30 ps



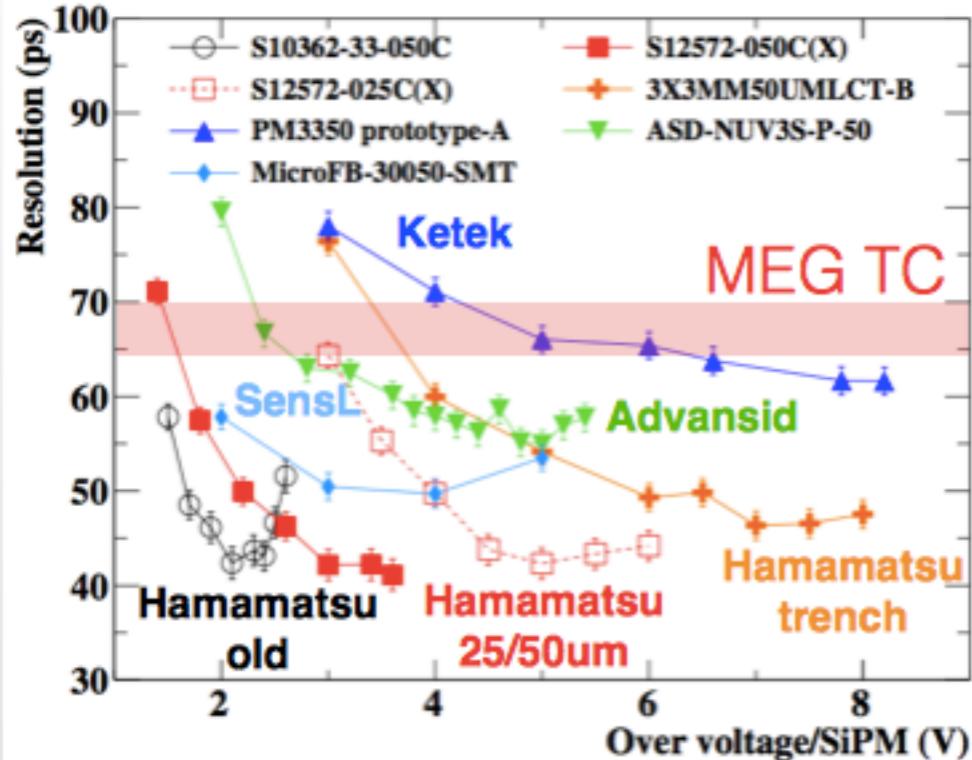
Single pixel R&D



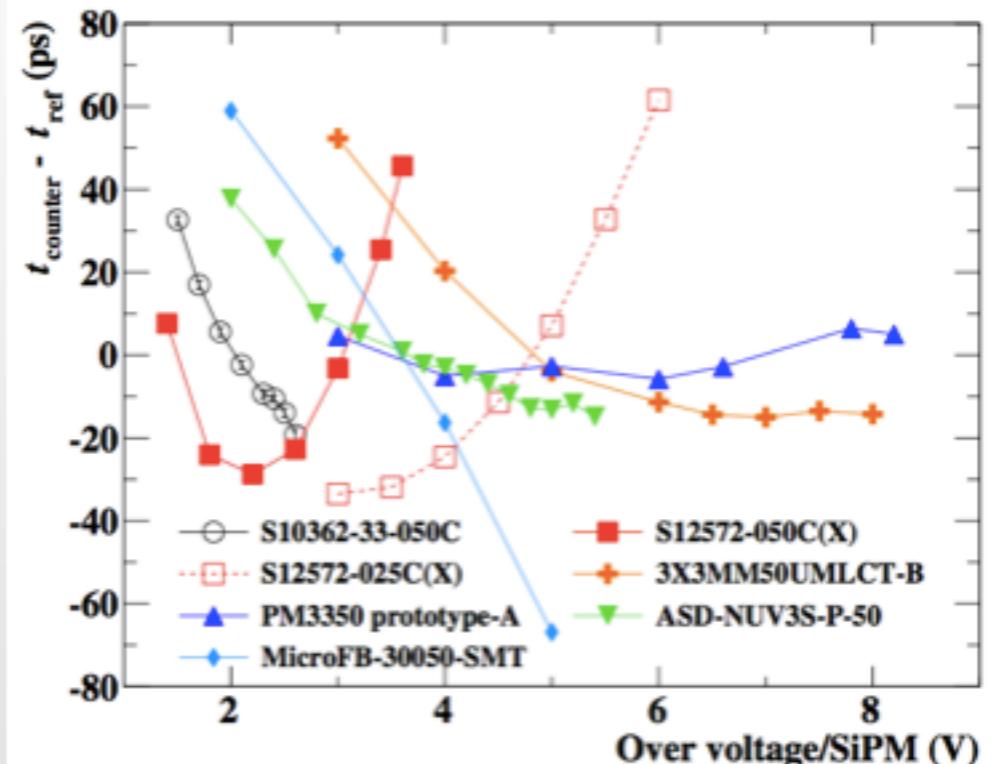
Multipixel prototypes and test for final design



M. De Gerone, A high resolution Timing counter for...



Best time reso with **Hamamatsu** device...but almost all devices work better than previous TC bar.



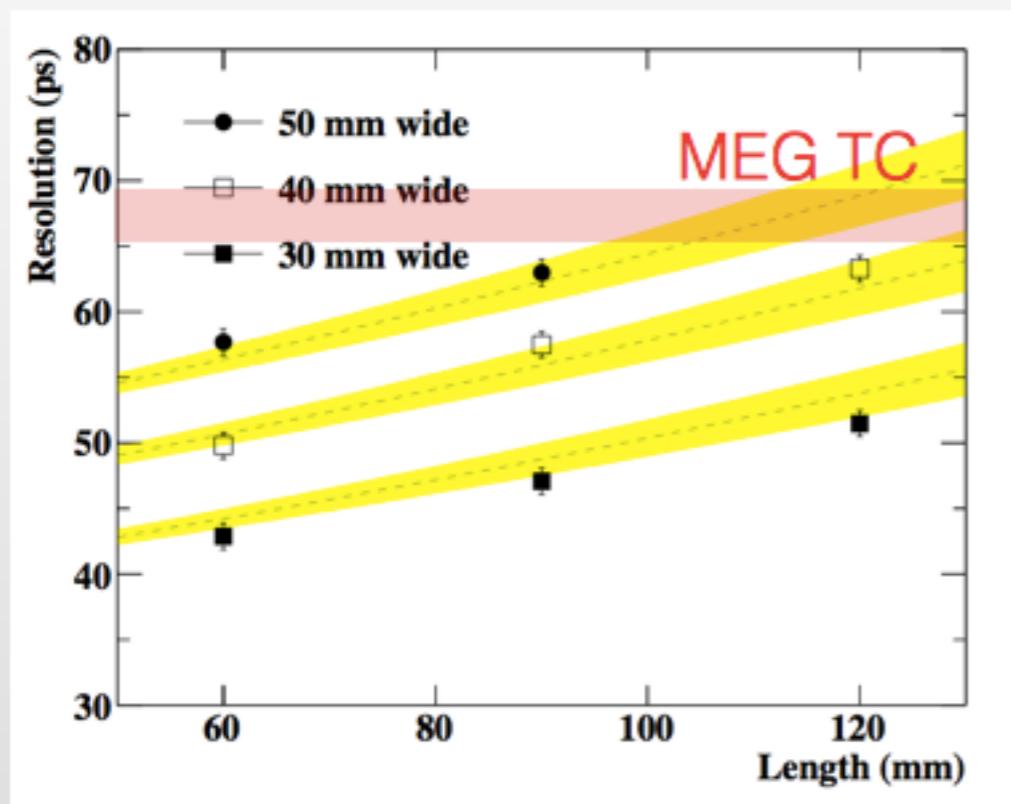
Advansid and **trench** devices are **more stable** as a function of over voltage and temperature.

HPK old	HPK new	HPK new 25um	HPK trench	Ketek	Advansid	SensL
2.5	5.5	2.8	0.1	0.1	0.2	0.8

Temperature coefficient: ps/ $^{\circ}\text{C}$

Temperature stability is a crucial parameter for our detector: $\Delta T \rightarrow \Delta V_{BD} \rightarrow \Delta V_{ov}$

Measurements with 4 SiPMs array in series connection (HAMAMATSU S10362-33-050C).

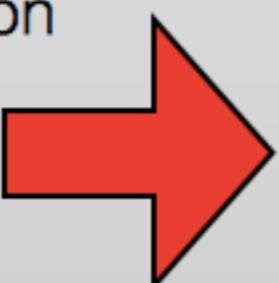


Properties	BC418	BC420	BC422	BC422Q
LY(%Anthracene)	67	64	55	19
Rise time (ns)	0.5	0.5	0.35	0.11
Decay time (ns)	1.4	1.5	1.6	0.7
Wavelength (peak, nm)	391	391	370	370
Attenuation length (cm)	100	110	2	8
Resolution (ps)	48±2	51±2	43±2	66±3

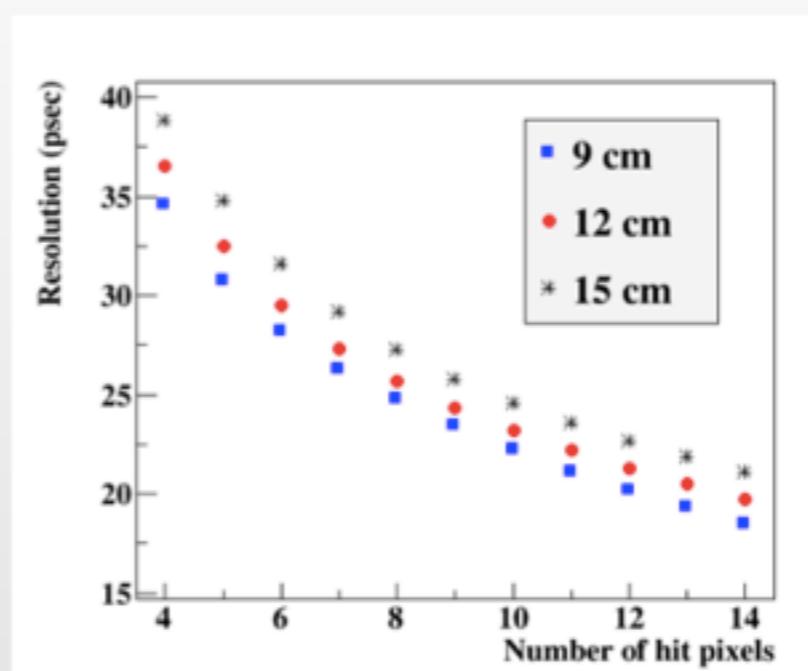
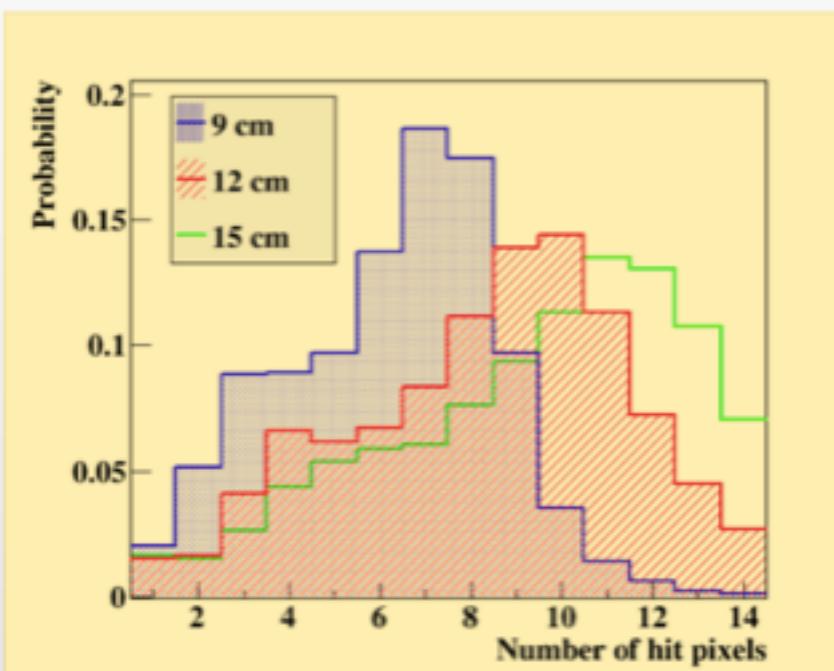
measured with $60 \times 30 \times 5 \text{ mm}^3$ pixels

All the configurations showed a **resolution better than 70ps** (same as old TC reso).
The final choice is done taking into account many factors:

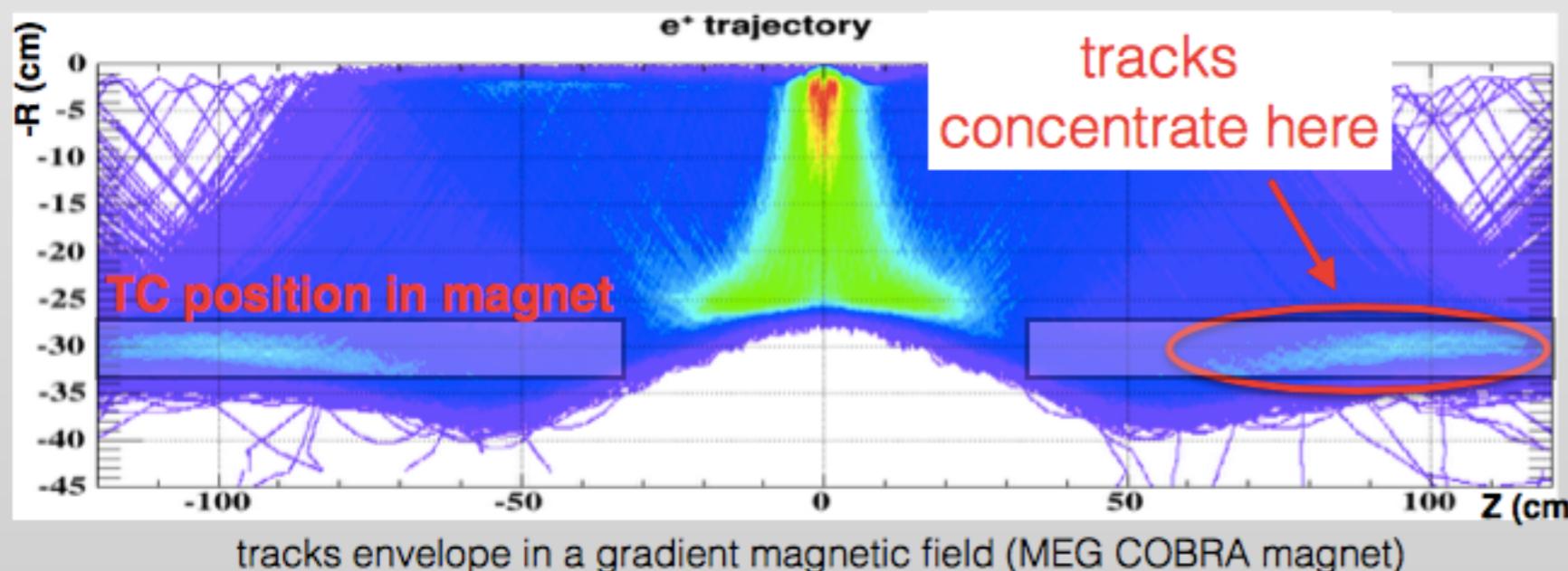
- intrinsic single pixel resolution
- expected number of hits
- efficiency
- number of channel
- costs



Numbers to be evaluated
on Monte Carlo
simulation...



120mm length pixel
is the best
compromise between
hit multiplicity, time
resolution and
number of channels.



different pixel height (40 or 50 mm) increases efficiency

- Double side read-out with **6 SiPMs (ASD-NUV3S-P) array** mounted in series connection on a PCB:
 - increase sensor coverage;
 - small material budget along positron trajectories: **PCBs act also as frame.**
- **120 x 50 (40) x 5 mm³ fast plastic scintillator (BC422)** coupled with optical cement, wrapped with reflector (3M mirror).
- Impact time and position reconstructed with sum / difference of single array time.
- **MCX connector for backplane plugging** (no cables on TC).



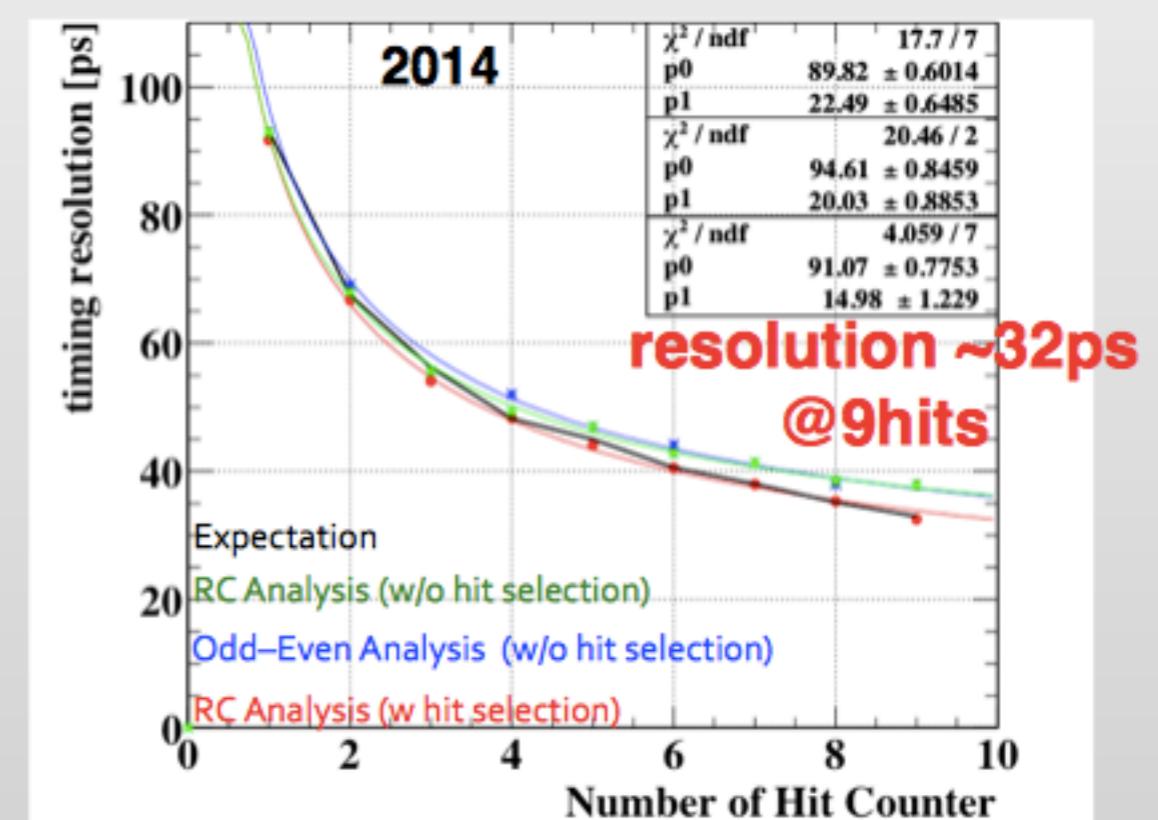
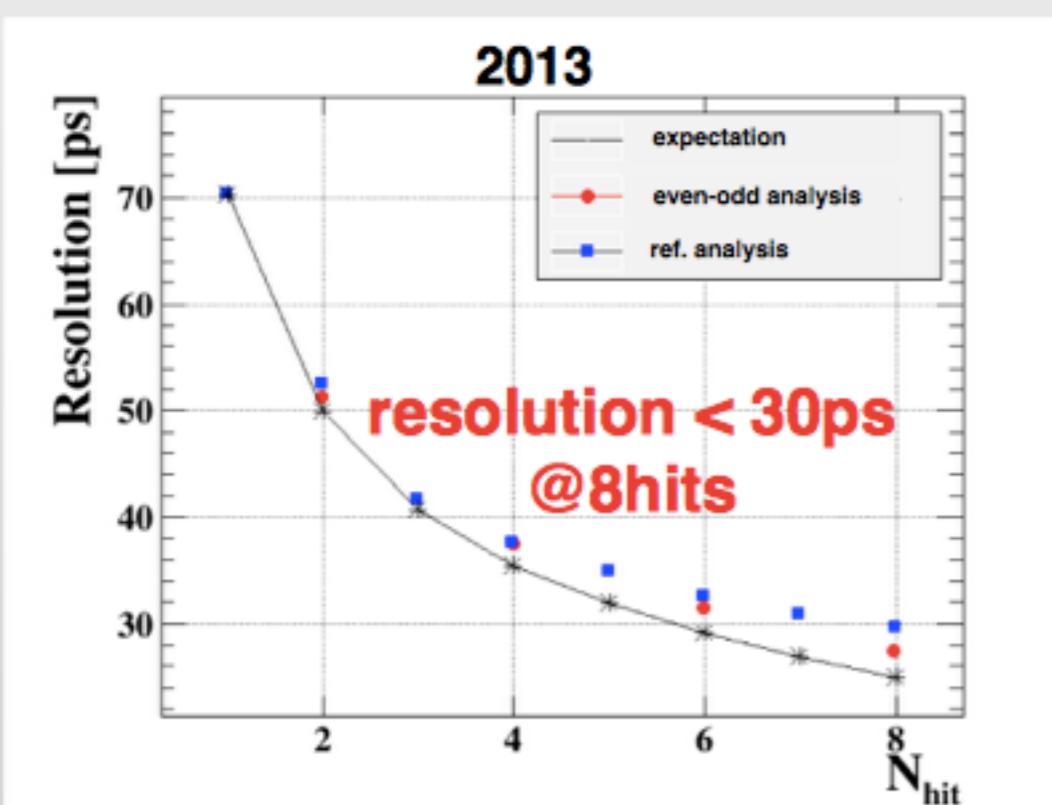
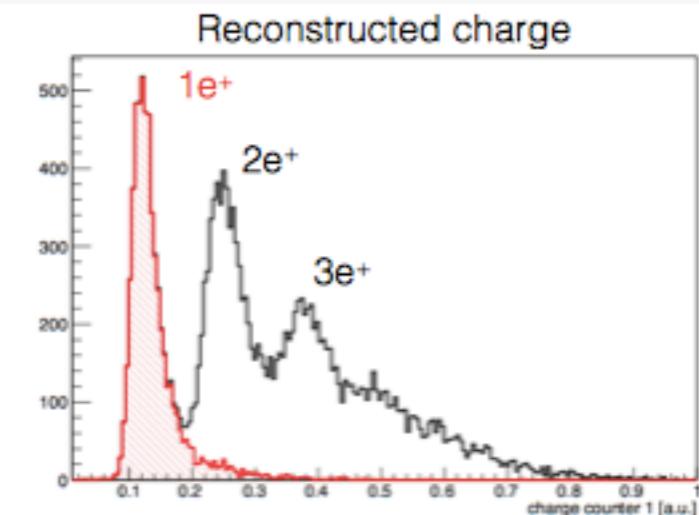
Time resolution evaluated as the width of

$$\Delta T(N) = T_{ref} - \frac{1}{N} \sum_{i=1}^N T_i$$

$$\Delta T(N) = \frac{1}{\sqrt{2}} \left[\frac{1}{N/2} \sum_{j=1}^{N/2} T_{a_j} - \frac{1}{N/2} \sum_{i=1}^{N/2} T_{b_i} \right]$$

RC analysis

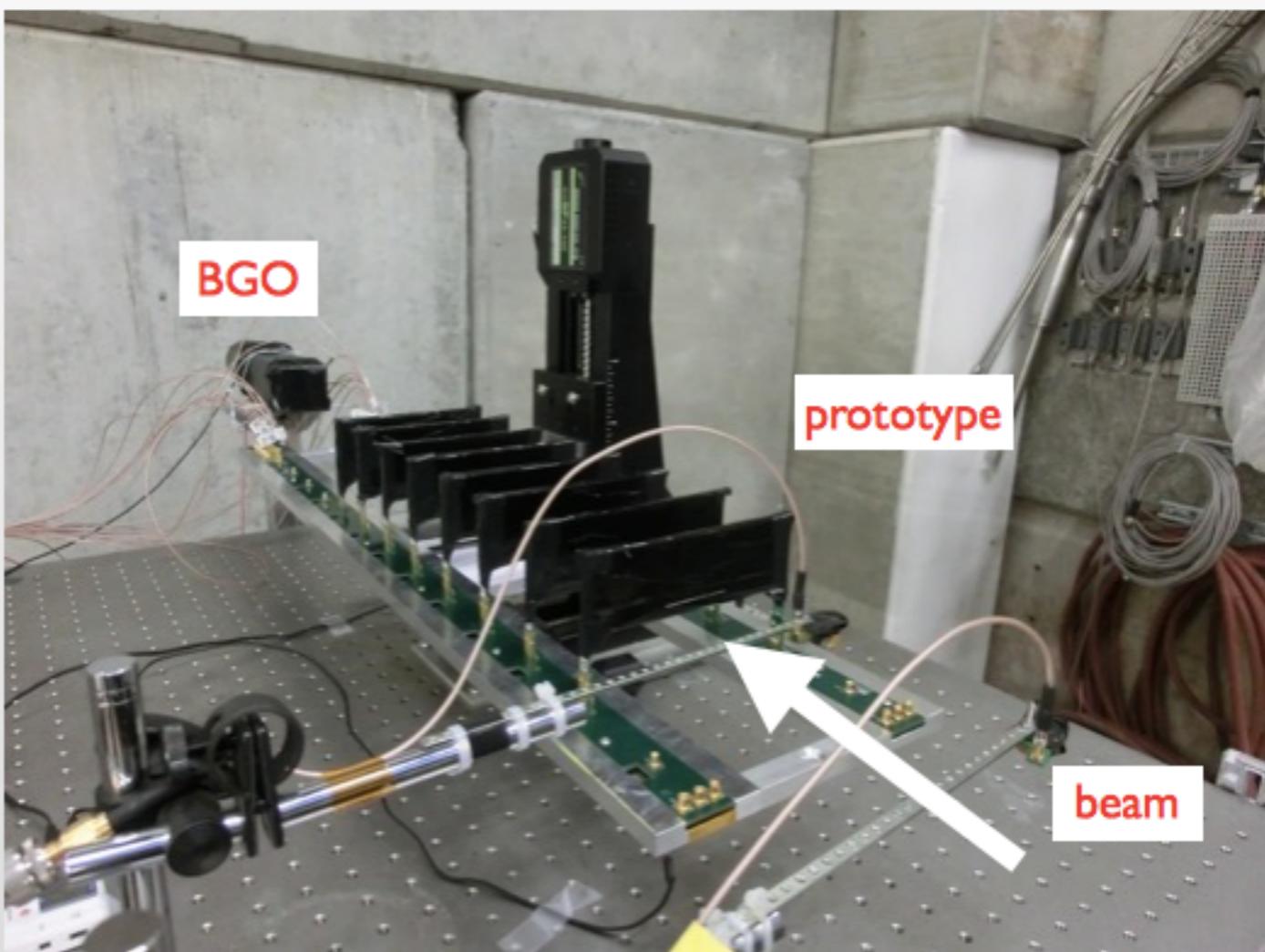
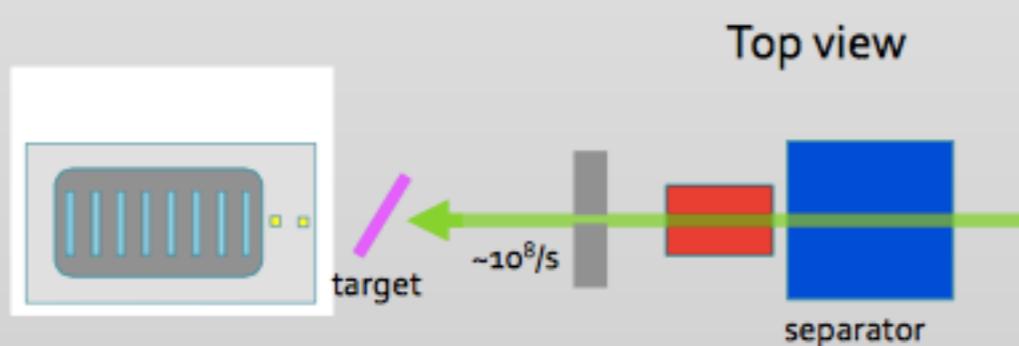
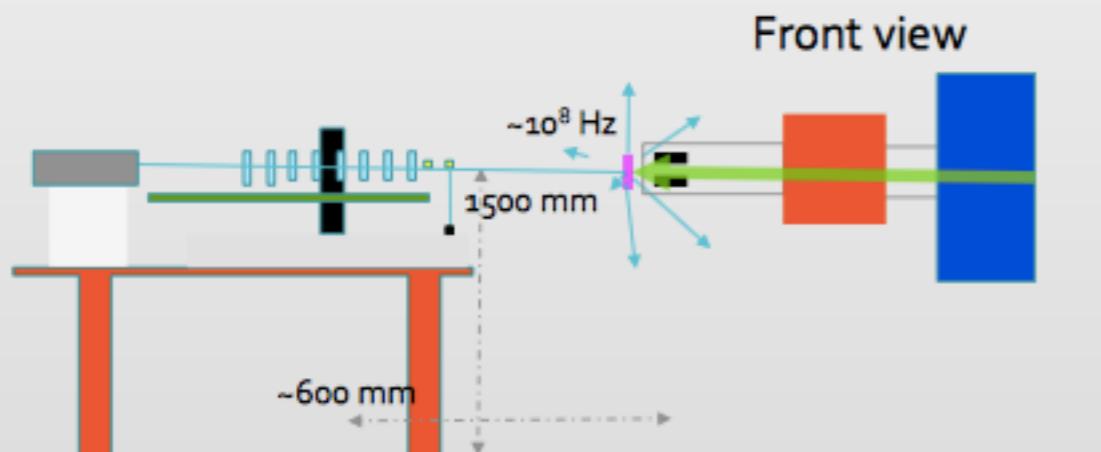
Odd/even
analysis



Differences due to:

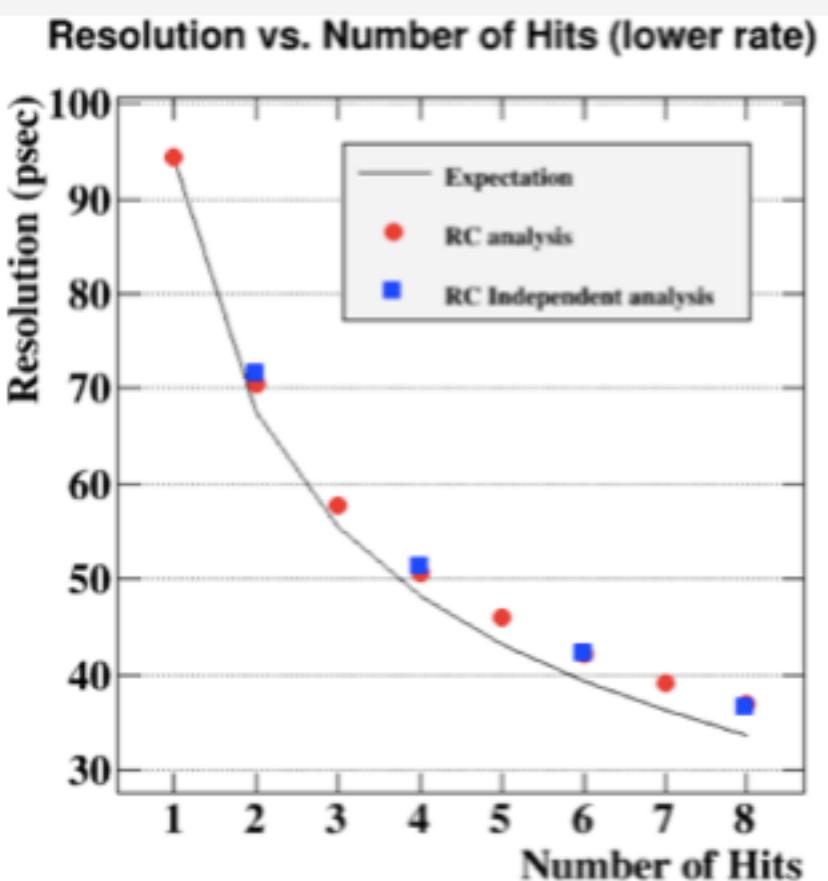
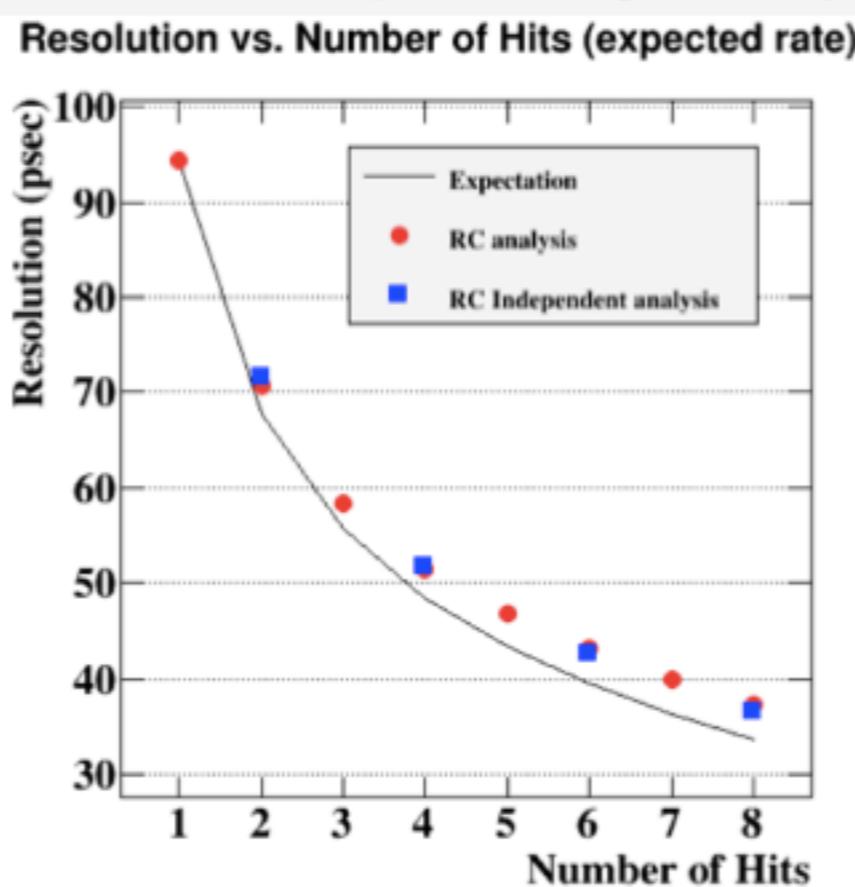
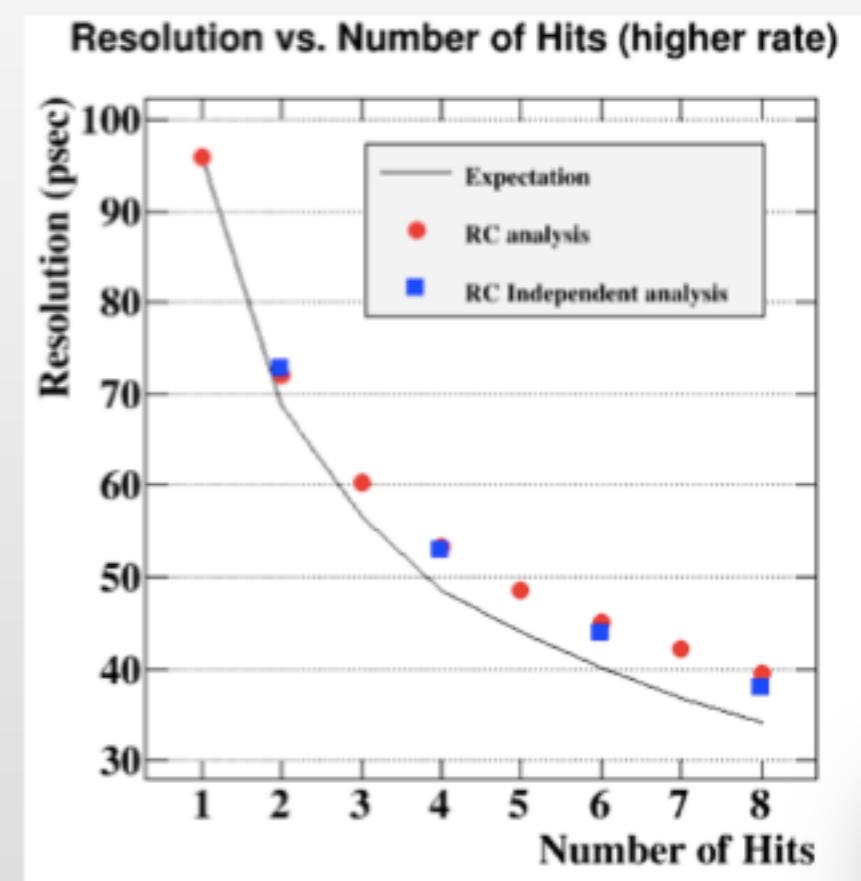
- Longer pixel (120mm vs 90mm)
- Different SiPM model

- **e⁺ from Michel decay**
- **hit rate as expected in MEG II**



μ -beam ($\pi e 5@\text{PSI}$), $\sim 10^8 \text{Hz}$ DC beam

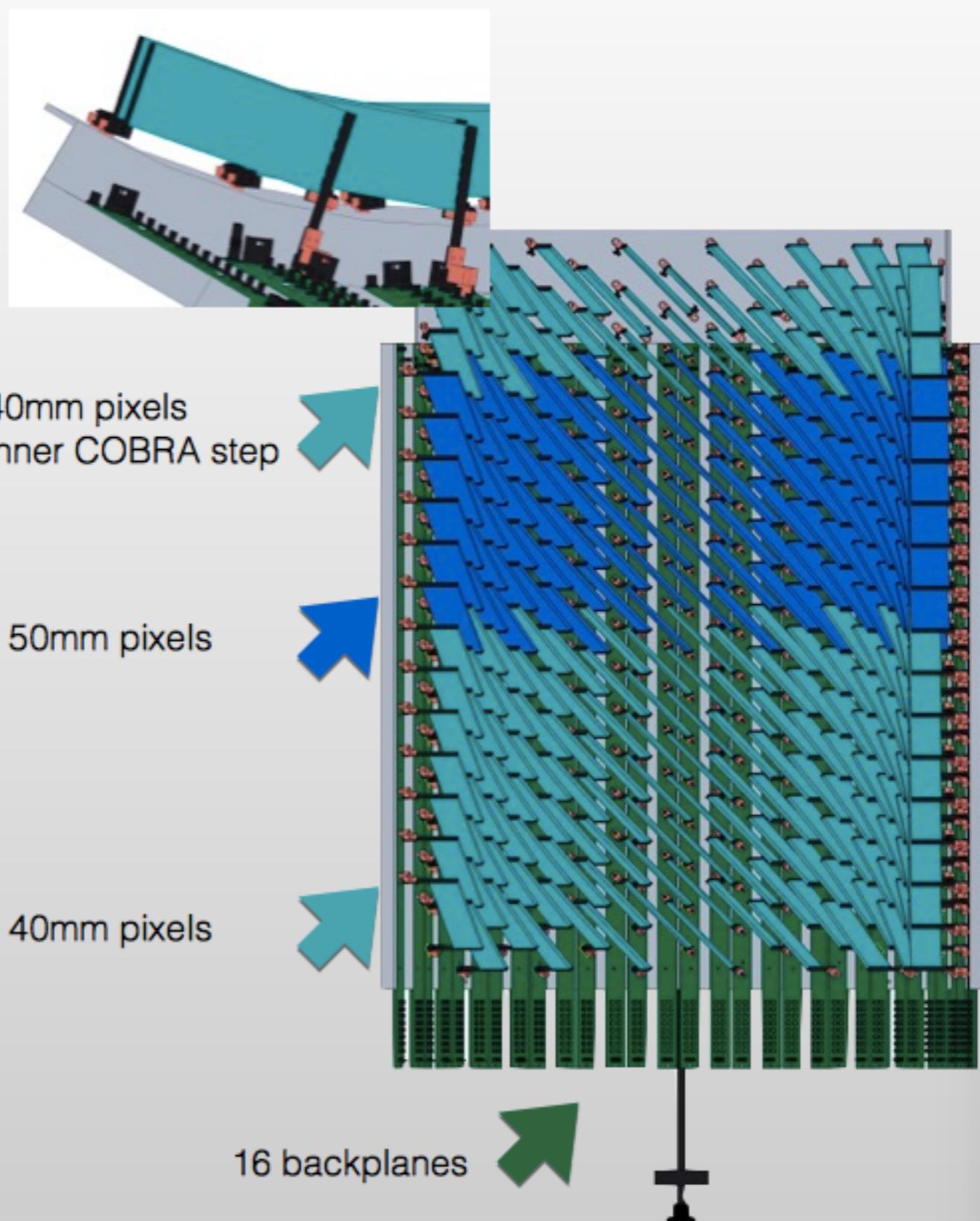
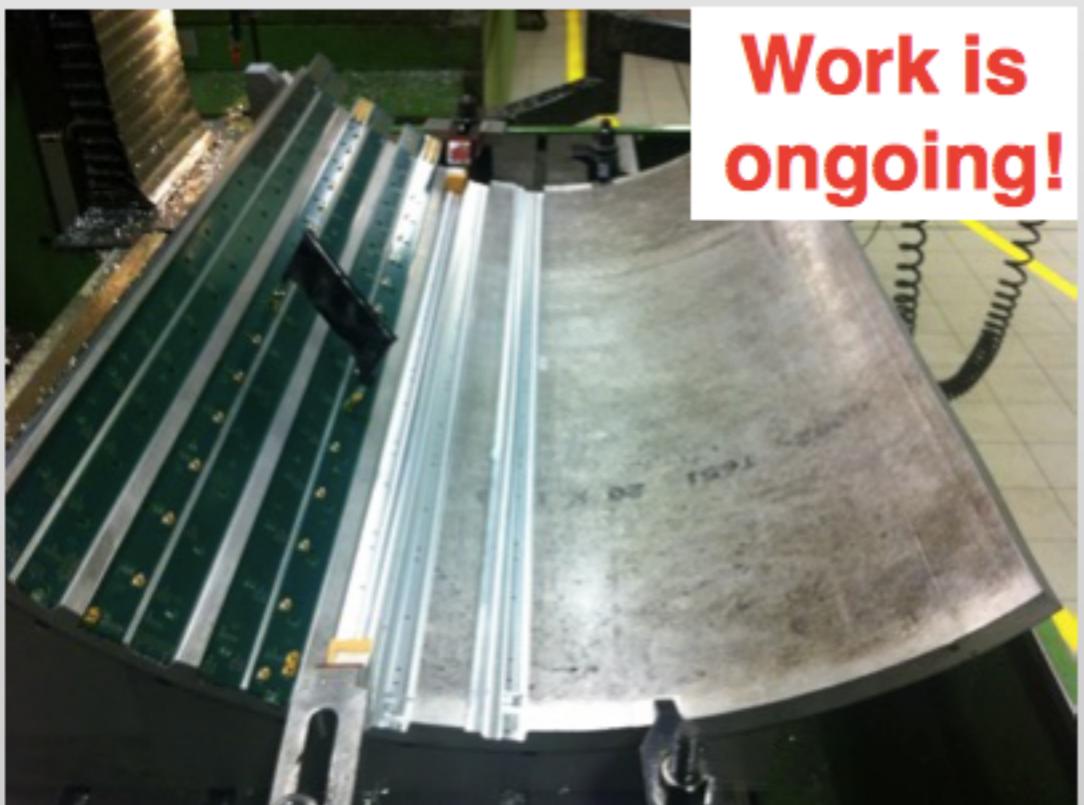
- **8 counters** mounted on **backplanes**
 - 6 $120 \times 40 \times 5 \text{mm}^3$ + 2 $120 \times 50 \times 5 \text{mm}^3$
 - **final pixel layout**
 - 2 RC counters (trigger/selection)
 - BGO calorimeter (beam monitoring)

20-60KHz**50-150KHz (MEG expected)****90-290KHz**

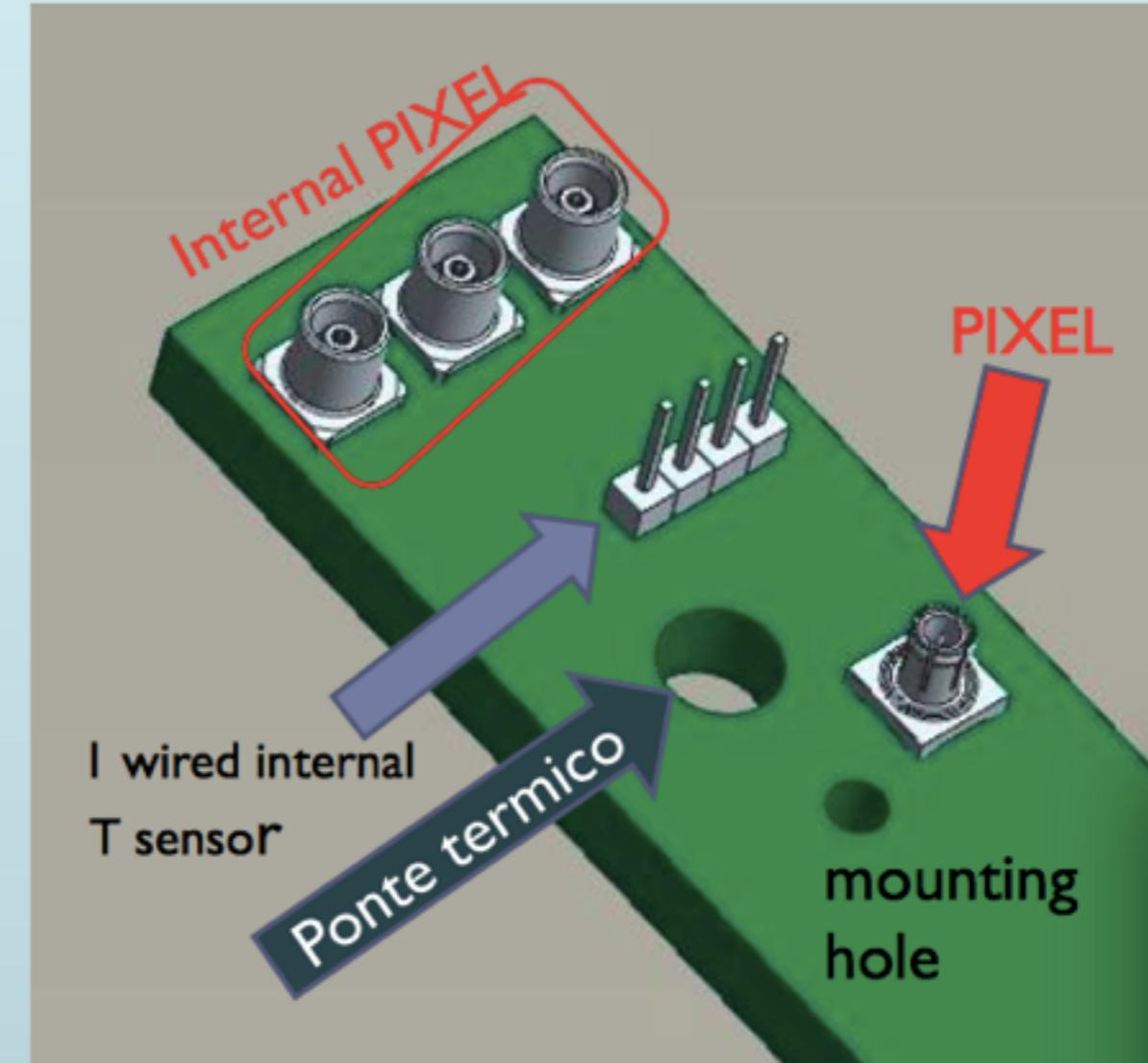
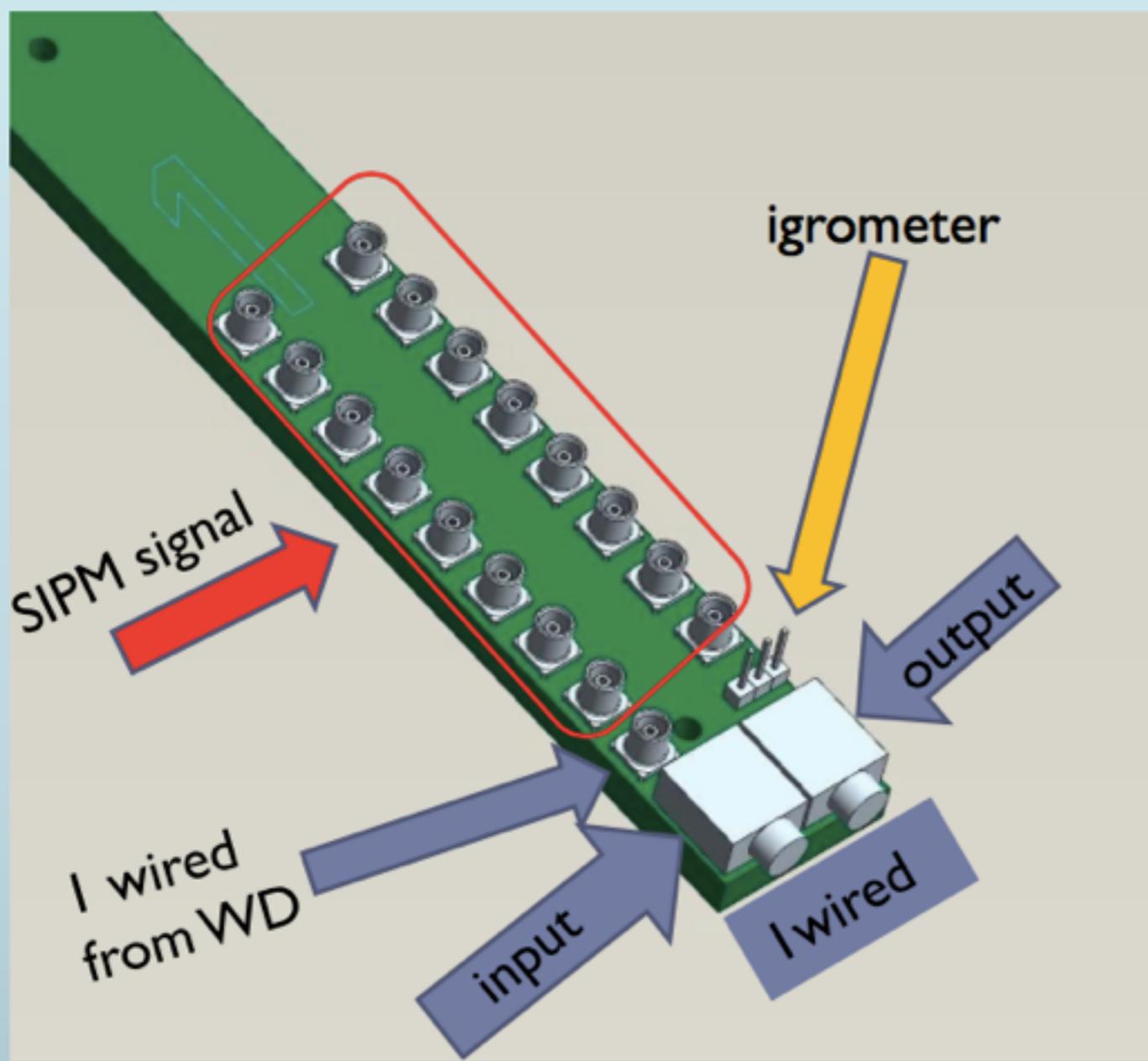
Resolution does not depend from beam rate in the range ~20-300 kHz.

~35ps resolution was found at the expected MEG II rate (~150 kHz).

- 256 **pixels** connected to **backplanes**
- **different heights** in different TC regions.
- optimized layout (fit mechanical constraints from magnet and DCH).
- expected reso ~30/35ps



details



- Contributi significativi
- Matteo De Gerone: coordinamento Design/Fab/Test
- F.Siccardi: Pixel & bus PCB design/fab/test
- A. Bevilacqua: Integration and Test

Anagrafica

Anagrafica MEG-1

	MEG
Gatti F	40
De Gerone M	80
Biasotti M	40
Pizzigoni G	80
totali FTE	2.4

Impegni servizi

EXP	JANUARY	FEBRUARY	MARCH	APRIL	MAY	JUNE	JULY	SEPTEMBER	OCTOBER
MEG									
Strutt Timing Counter Commissioning		Off.Mec.: End of Fabrication and Commissioning 4 mu							
		Dis.Mec.: Final support 2 mu							